

FIG. 1
(PRIOR ART)

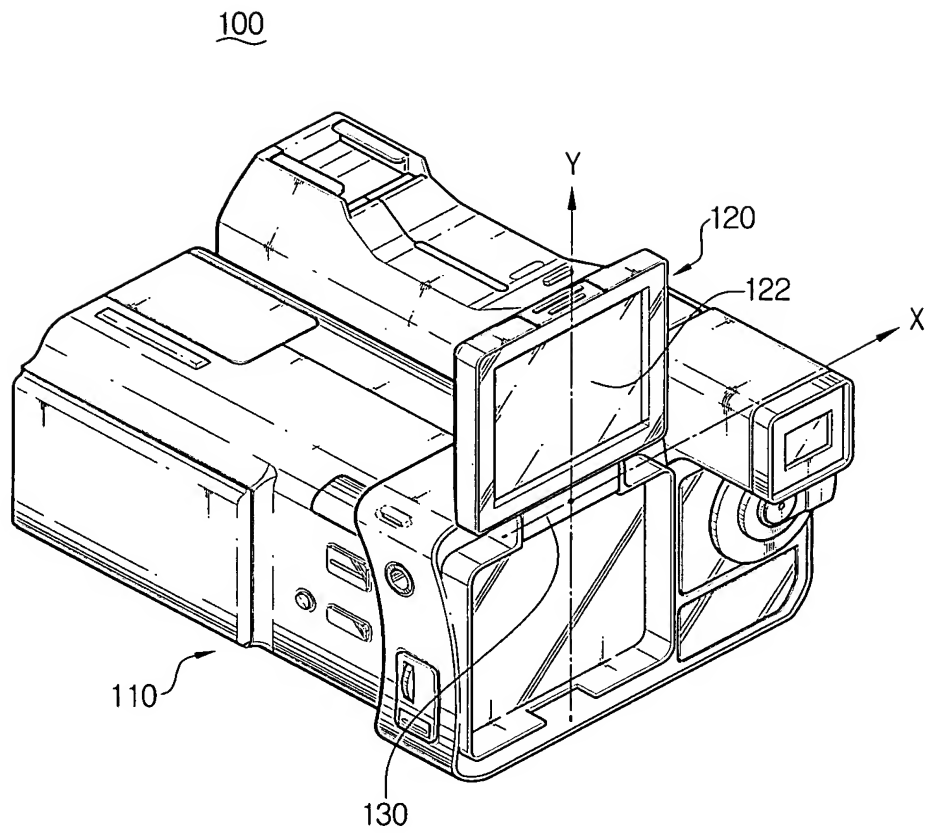


FIG. 2
(PRIOR ART)

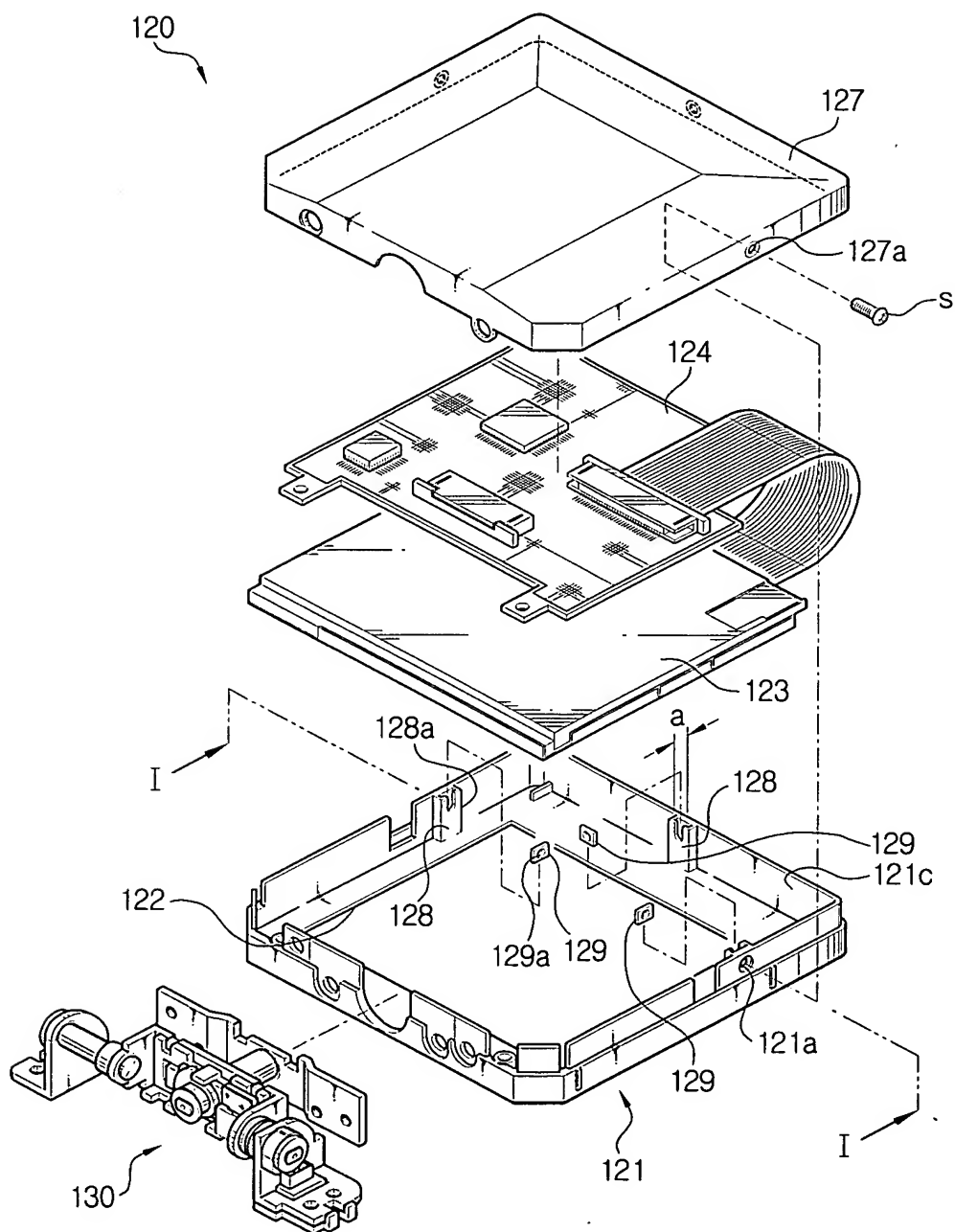


FIG. 3
(PRIOR ART)

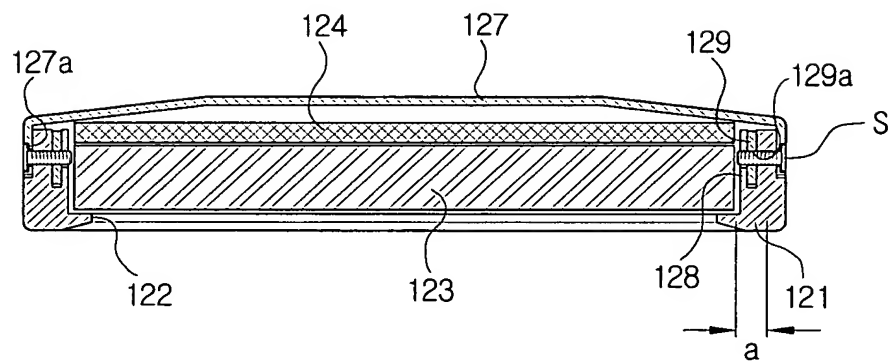
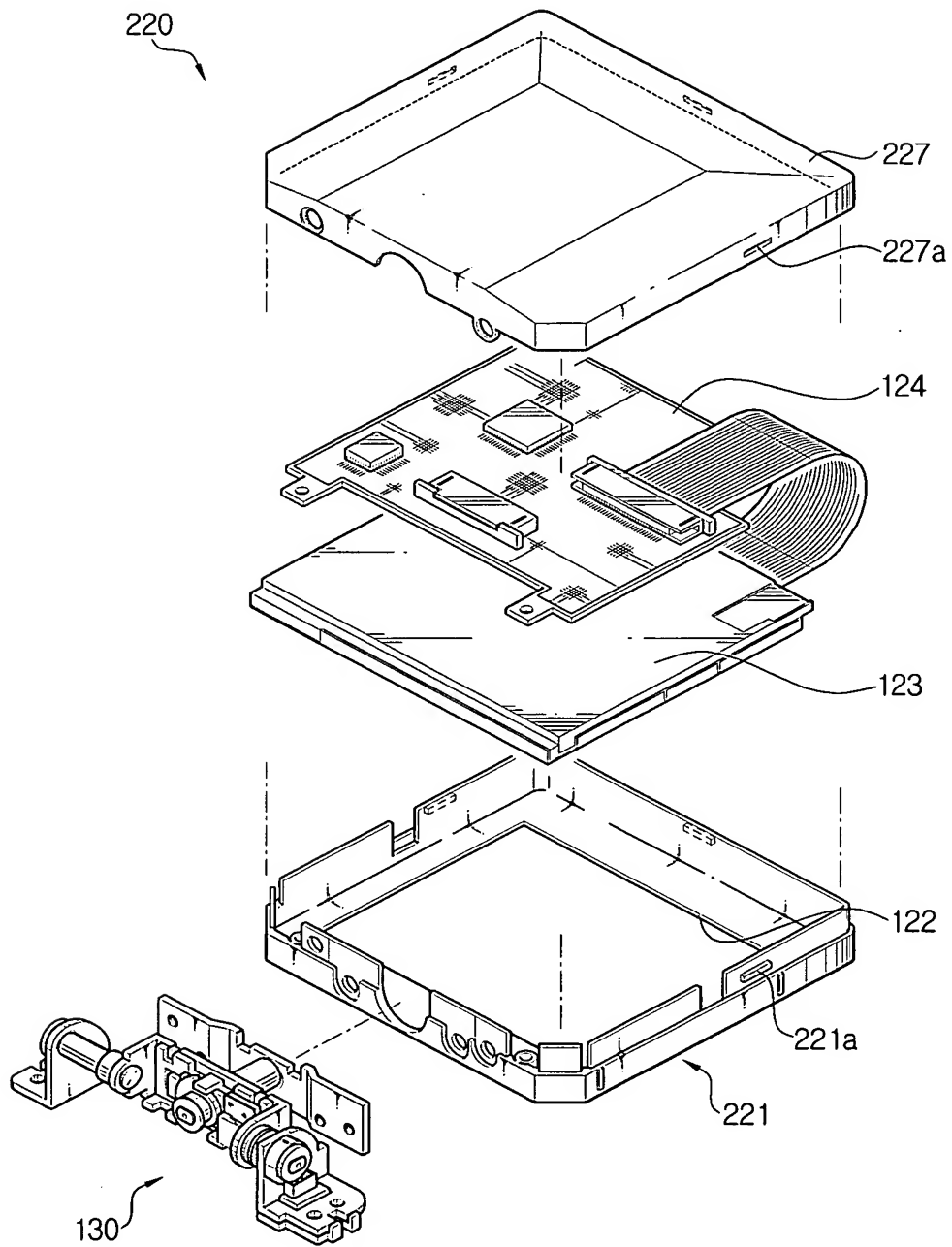


FIG. 4
(PRIOR ART)



This exploded perspective view shows the assembly of the device 100. It includes a top housing 122, a middle circuit board 123, and a bottom housing 121. The top housing 122 features a top surface 124 with a central component 124a and a side surface 127. The middle circuit board 123 has a top surface 124a and a bottom surface 123b. The bottom housing 121 has a bottom surface 121a and a side surface 121c. A hinge assembly 130 is shown at the bottom left, which includes a hinge pin 130a and a hinge bracket 130b. The assembly is shown in an exploded state, with dashed lines indicating the alignment of the components. A dimension line 't' indicates the thickness of the top housing 122. Various fasteners 329 are shown securing the components together. A detail view 'A' is shown at the bottom right, illustrating the hinge assembly 130 in a closed position, with labels 327a, 327b, 327c, 328, 328a, 328b, 329a, and 329b.

FIG. 6

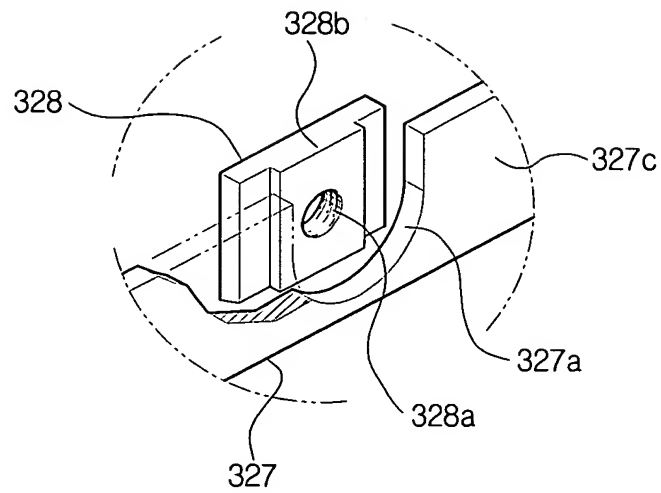


FIG. 7

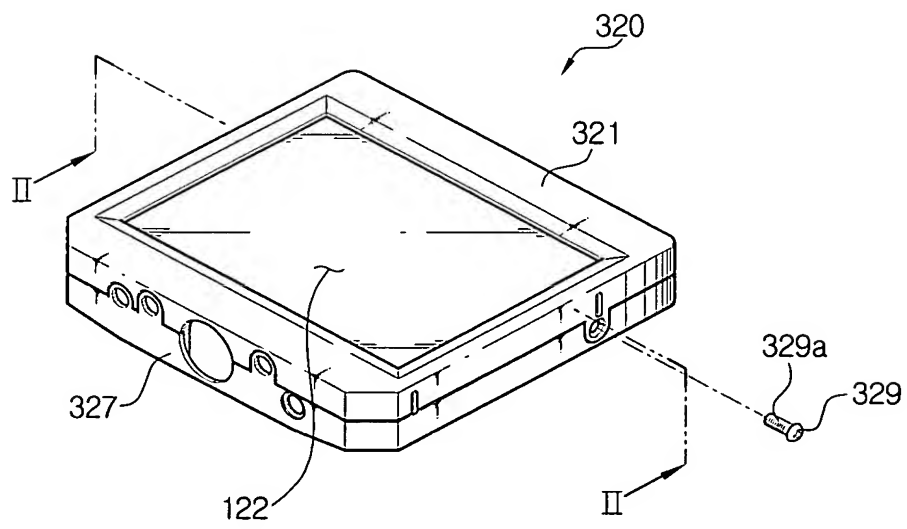


FIG. 8

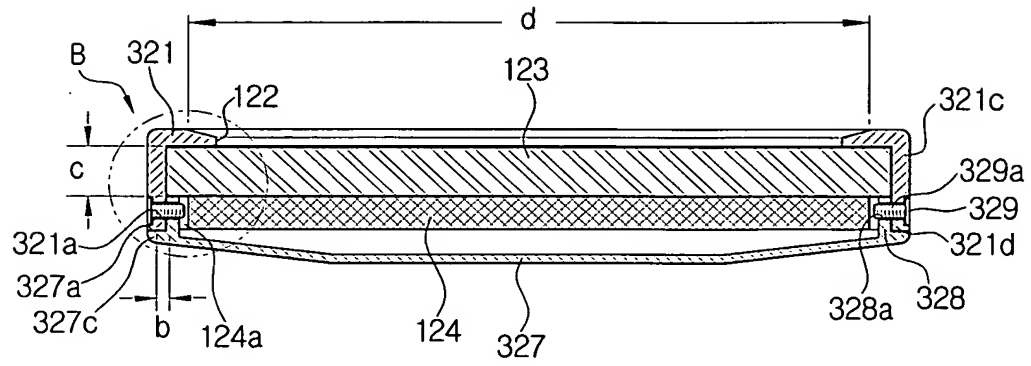


FIG. 9

